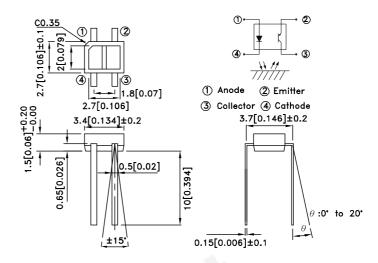
# **Kingbright**

#### SUBMINIATURE, HIGH SENSITIVITY PHOTOINTERRUPTER

#### \*Features

- Compact and thin
- Visible light cut-off type
- High sensitivity
- Moisture sensitivity level: 4
- RoHS Compliant



### \*Applications

- Cassette tape recorders, VCRs.
- Floppy disk drives.
- Various microcomputerized control equipment.

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

### \*Absolute Maximum Ratings Ta=25°C

Parameter			Rating	Unit
Input	Forward current		50	mA
	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation	PD	75	mW
	Peak Forward Current (Pulse Width ≤100uS, Duty Cycle =1%)	I <sub>FP</sub>	1	Α
Output	Collector-emitter voltage	V <sub>CEO</sub>	35	V
	Emitter-collector voltage	V <sub>ECO</sub>	6	V
	Collector current	Ic	20	mA
	Collector power dissipation	Pc	75	mW
Operating temperature		Topr	-25~+85	°C
Storage temperature		Tstg	-40~+100	°C
soldering temperature (1/16 inch from body for 5 seconds)			260	°C

#### Note

1.Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



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■Electro-optical Characteristics									
Parameter		Symbol	Conditions	Min.	TYP.	Max.	Unit		
Input	Forward Voltage		V <sub>F</sub>	I <sub>F</sub> =20mA	1.0	1.2	1.5	V	
	Reverse Current		I <sub>R</sub>	V <sub>R</sub> =6V	-	-	10	μΑ	
	Peak Wavelength		λР	I <sub>F</sub> =20mA	-	940	-	nm	
Output	Collector Dark C	urrent	I <sub>CEO</sub>	V <sub>CE</sub> =20V	-	10 <sup>-9</sup>	10 <sup>-7</sup>	Α	
Transfer charact-eristics	*1 Collector Current		Ic	V <sub>CE</sub> =2V I <sub>F</sub> =4mA	10	-	400	μΑ	
	*2 Leak Current		I <sub>LEAK</sub>	V <sub>CE</sub> =2V I <sub>F</sub> =4mA	-	-	0.1	μА	
	Response time	Rise time	tr	V <sub>CE</sub> =2V	-	20	100	μsec	
		Fall time	tf	$I_C=100\mu A$ R <sub>L</sub> =1K $\Omega$ ,d=1mm	-	20	100	μsec	

<sup>\*1</sup> The condition and arrangement of the reflective object are shown below.

<sup>\*3</sup> Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

BIN CODE	lc (uA)
E	10-120
F	100-250
G	200-400

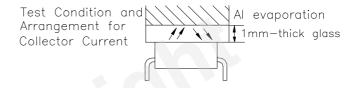


Fig. 1 Forward Current vs.
Forward Voltage

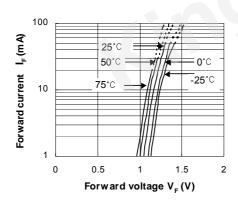


Fig. 2 Collector Current vs. Forward Current

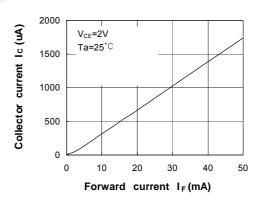


Fig. 3 Collector Current vs.

Collector—emitter Voltage

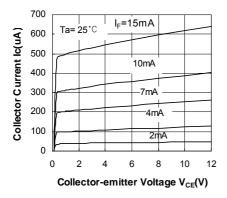
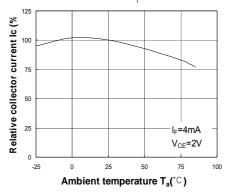


Fig. 4 Relative Collector Current vs.

Ambient Temperature



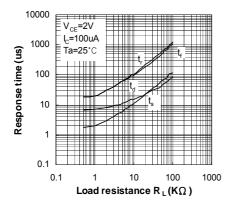
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<sup>\*2</sup> Without reflective object.

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Fig. 5 Response Time vs. Load Resistance



Test Circuit for Response Time

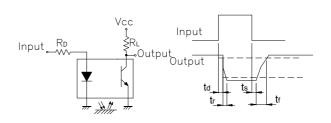
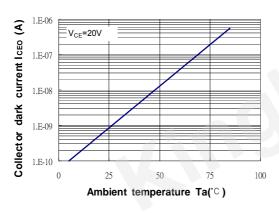


Fig. 6 Collector Dark Current vs. Fig. 7 Relative Collector Current vs. Ambient Temperature



Distance between Sensor and Al Evaporation Glass

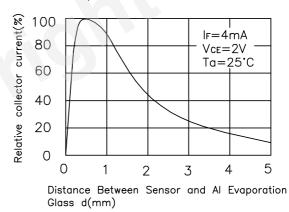
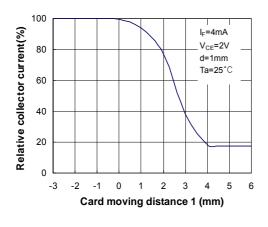
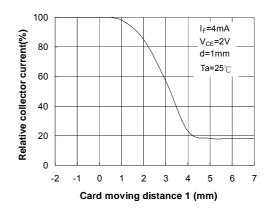
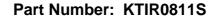


Fig. 8 Relative Collector Current vs. Fig. 9 Relative Collector Current vs. Card Moving Distance (1) Card Moving Distance (2)





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## **Test Condition for Distance&Detecting Position Characteristics**

Correpond to Fig. 7



Correpond to Fig. 8
Test condition

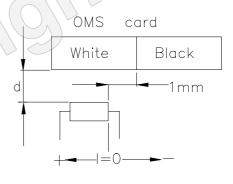
I<sub>F</sub>=4mA V<sub>CE</sub>=2V d=1mm

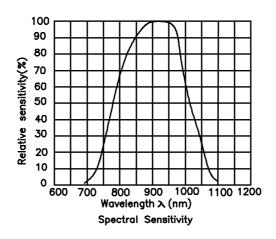
OMS card
White Black

d 1mm

Correpond to Fig. 9
Test condition

IF=4mA VcE=2V d=1mm





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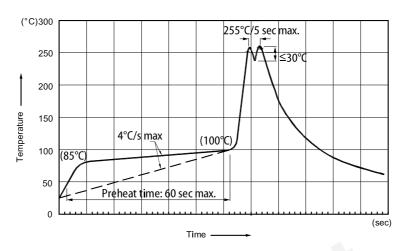
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### **Wave Soldering Profile**

Wave Soldering Profile For Lead-free Through-hole LED.

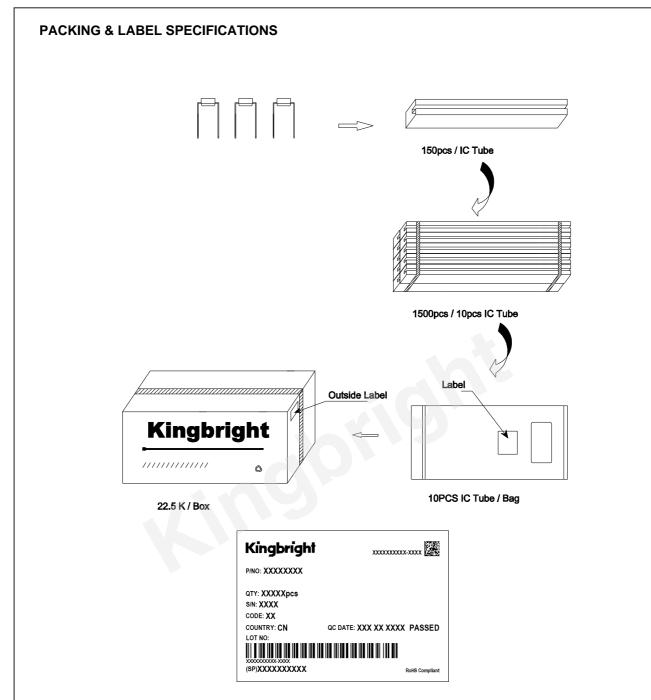


#### Notes:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- 3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5. SAC 305 solder alloy is recommended.
- 6. No more than one wave soldering pass.

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